National Semiconductor

54F/74F646 • 74F646B • 54F/74F648
Octal Transceiver/Register with TRI-STATE® Outputs

General Description

These devices consist of bus transceiver circuits with TRI-STATE, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes to a high logic level. Control $\overline{G}$ and direction pins are provided to control the transceiver function. In the transceiver mode, data present at the high impedance port may be stored in either the A or the B register or in both. The select controls can multiplex stored and real-time (transparent mode) data. The direction control determines which bus will receive data when the enable control $\overline{G}$ is Active LOW. In the isolation mode (control $\overline{G}$ HIGH), A data may be stored in the B register and/or B data may be stored in the A register.

Features

- Independent registers for A and B buses
- Multiplexed real-time and stored data
- 'F648 has inverting data paths
- 'F646/'F646B have non-inverting data paths
- 'F646B is a faster version of the 'F646
- TRI-STATE outputs
- 300 mil slim DIP
- Guaranteed 4000V minimum ESD protection

Ordering Code: See Section 11

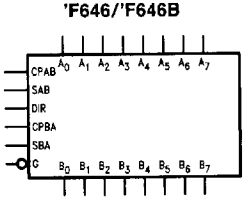
Commercial	Military	Package Number	Package Description
74F646SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
	54F646DM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line
74F646SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
74F646MSA (Note 1)		MSA24	24-Lead Molded Shrink Small Outline, EIAJ, Type II
	54F646FM (Note 2)	W24C	24-Lead Cerpack
	54F646LM (Note 2)	E28A	28-Lead Ceramic Leadless Chip Carrier, Type C
74F646BSPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
74F646BSC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
74F648SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
	54F648SDM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line
74F648SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
	54F648FM (Note 2)	W24C	24-Lead Cerpack
	54F648LM (Note 2)	E28A	24-Lead Ceramic Leadless Chip Carrier, Type C

Note 1: Devices also available in 13" reel. Use suffix = SCX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

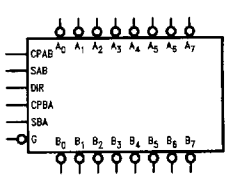
Logic Symbols

'F646/'F646B



TL/F/9580–1

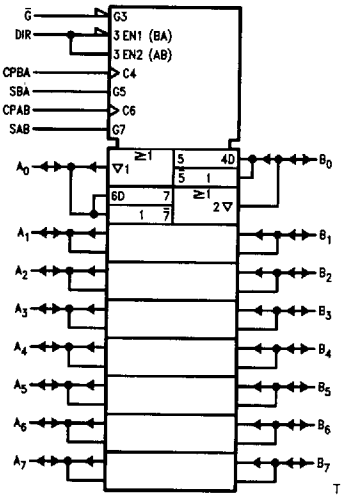
'F648



TL/F/9580–7

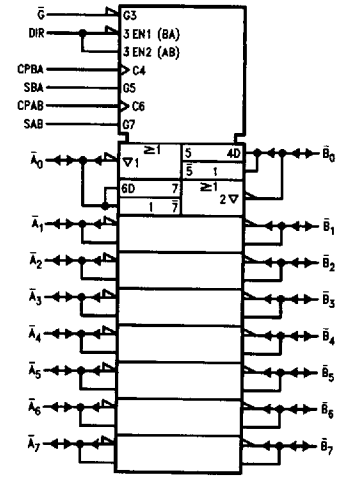
Logic Symbols (Continued)

IEEE/IEC
'F646/'F646B



TL/F/9580–4

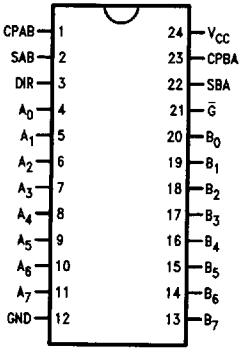
IEEE/IEC
'F648



TL/F/9580–9

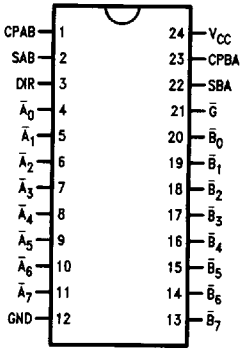
Connection Diagrams

Pin Assignment
for DIP, SOIC and Flatpak
'F646/'F646B



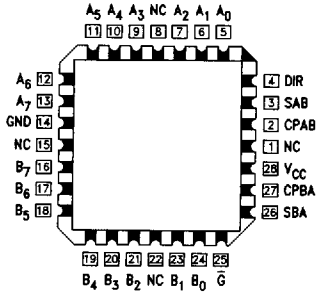
TL/F/9580–2

Pin Assignment
for DIP, SOIC and Flatpak
'F648



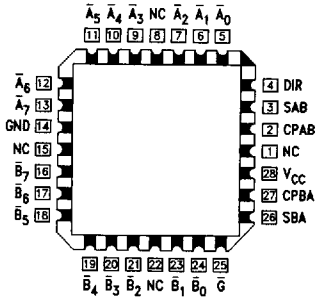
TL/F/9580–8

Pin Assignment
for LCC
'F646/'F646B



TL/F/9580–3

Pin Assignment
for LCC
'F648



TL/F/9580–10

Unit Loading/Fan Out: See Section 2 for U.L. definitions

Pin Names	Description	54F/74F	
		U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
A_0–A_7	Data Register A Inputs/ TRI-STATE Outputs	3.5/1.083 600/106.6 (80)	70 μA/−650 μA −12 mA/64 mA (48 mA)
B_0–B_7	Data Register B Inputs/ TRI-STATE Outputs	3.5/1.083 600/106.6 (80)	70 μA/−650 μA −12 mA/64 mA (48 mA)
CPAB, CPBA	Clock Pulse Inputs	1.0/1.0	20 μA/−0.6 mA
SAB, SBA	Select Inputs	1.0/1.0	20 μA/−0.6 mA
$\overline{G}$	Output Enable Input	1.0/1.0	20 μA/−0.6 mA
DIR	Direction Control Input	1.0/1.0	20 μA/−0.6 mA

Function Table

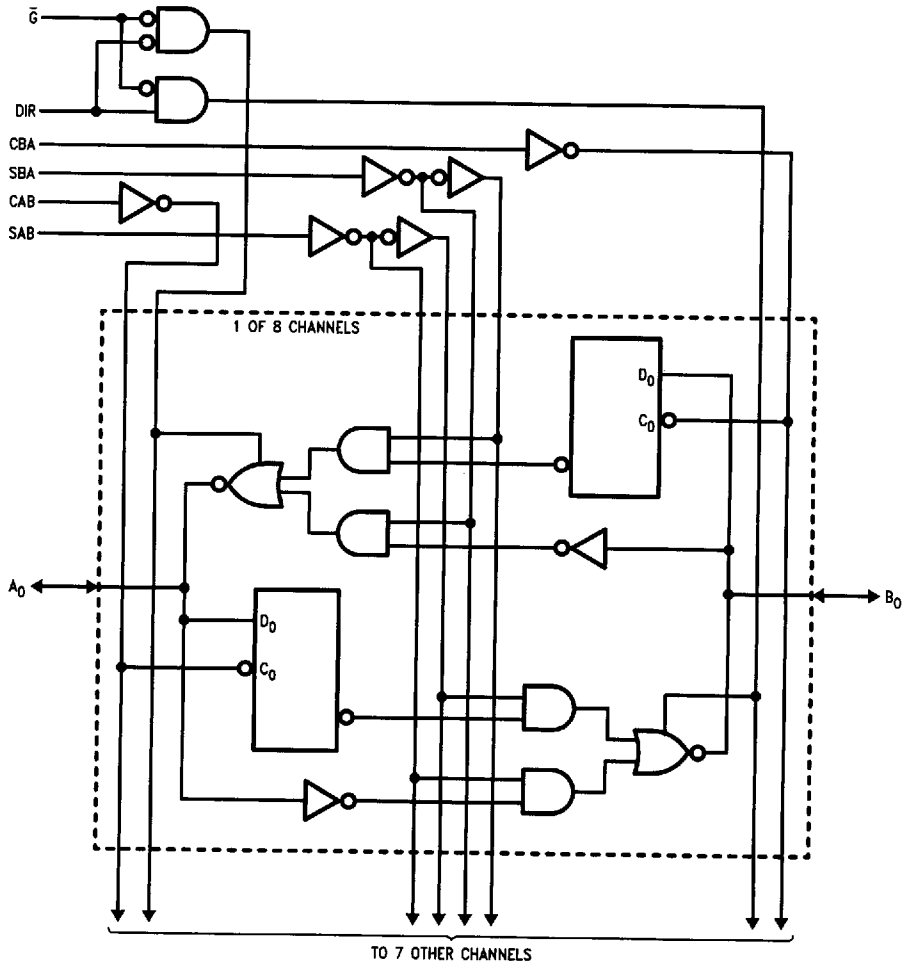
Inputs						Data I/O*		Function
$\overline{G}$	DIR	CPAB	CPBA	SAB	SBA	A_0–A_7	B_0–B_7	
H	X	H or L	H or L	X	X	Input	Input	Isolation
H	X	↑	X	X	X			Clock A_n Data into A Register
H	X	X	↑	X	X			Clock B_n Data into B Register
L	H	X	X	L	X	Input	Output	A_n to B_n—Real Time (Transparent Mode)
L	H	↑	X	L	X			Clock A_n Data into A Register
L	H	H or L	X	H	X			A Register to B_n (Stored Mode)
L	H	↑	X	H	X			Clock A_n Data into A Register and Output to B_n
L	L	X	X	X	L	Output	Input	B_n to A_n—Real Time (Transparent Mode)
L	L	X	↑	X	L			Clock B_n Data into B Register
L	L	X	H or L	X	H			B Register to A_n (Stored Mode)
L	L	X	↑	X	H			Clock B_n Data into B Register and Output to A_n

*The data output functions may be enabled or disabled by various signals at the $\overline{G}$ and DIR Inputs. Data input functions are always enabled; i.e., data at the bus pins will be stored on every LOW-to-HIGH transition of the clock inputs.

H = HIGH Voltage Level
L = LOW Voltage Level
X = Irrelevant
↑ = LOW-to-HIGH Transition

Logic Diagrams (Continued)

'F646/'F646B

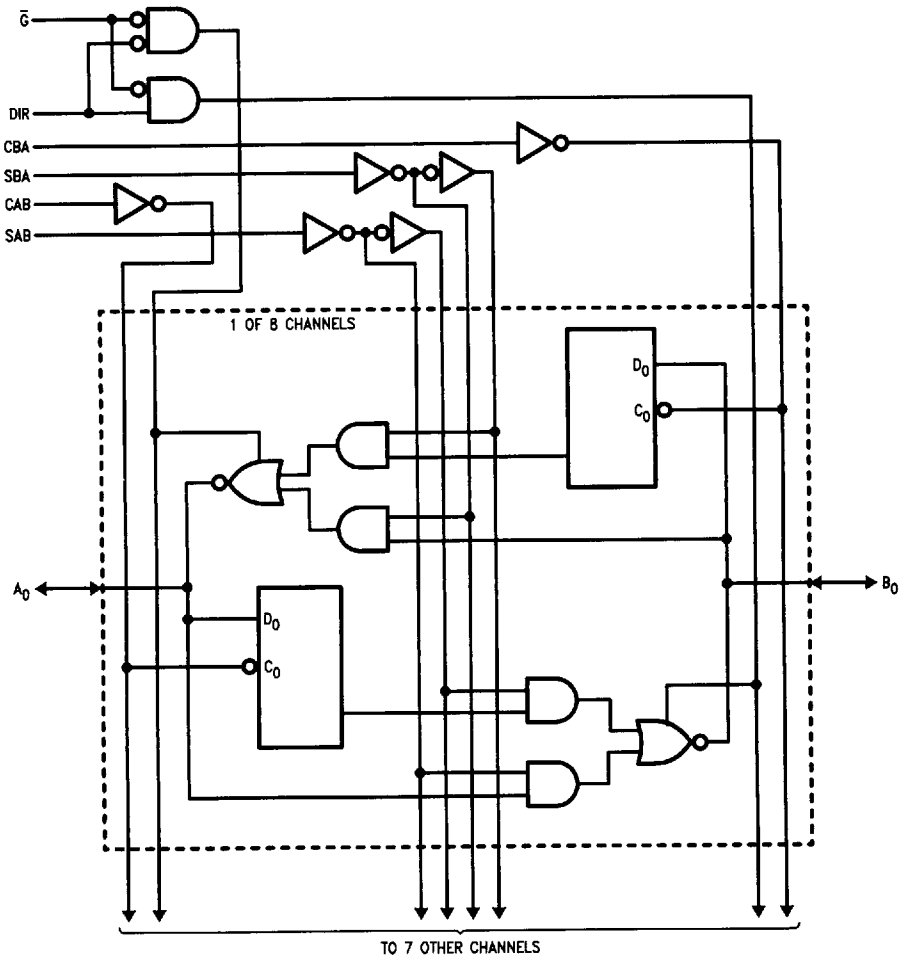


TL/F/9580–5

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Logic Diagrams (Continued)

'F648



TL/F/9580–6

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	−65°C to +150°C
Ambient Temperature under Bias	−55°C to +125°C
Junction Temperature under Bias	−55°C to +175°C
Plastic	−55°C to +150°C
V_{CC} Pin Potential to Ground Pin	−0.5V to +7.0V
Input Voltage (Note 2)	−0.5V to +7.0V
Input Current (Note 2)	−30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V_{CC} = 0V)	
Standard Output	−0.5V to V_{CC}
TRI-STATE Output	−0.5V to +5.5V
Current Applied to Output in LOW State (Max)	twice the rated I_{OL} (mA)
ESD Last Passing Voltage (Min)	4000V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature	
Military	−55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

DC Electrical Characteristics

Symbol	Parameter		54F/74F Min	54F/74F Typ	54F/74F Max	Units	V_{CC}	Conditions
V_{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal
V_{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal
V_{CD}	Input Clamp Diode Voltage				−1.2	V	Min	I_{IN} = −18 mA (Non I/O Pins)
V_{OH}	Output HIGH Voltage	54F 10% V_{CC}	2.0			V	Min	I_{OH} = −12 mA (A_n, B_n)
		74F 10% V_{CC}	2.0					I_{OH} = −15 mA (A_n, B_n)
V_{OL}	Output LOW Voltage	54F 10% V_{CC}			0.55	V	Min	I_{OL} = 48 mA (A_n, B_n)
		74F 10% V_{CC}			0.55			I_{OL} = 64 mA (A_n, B_n)
I_{IH}	Input HIGH Current	54F			20.0	μA	Max	V_{IN} = 2.7V (Non I/O Pins)
		74F			5.0			
I_{BVI}	Input HIGH Current Breakdown Test	54F			100	μA	Max	V_{IN} = 7.0V (Non I/O Pins)
		74F			7.0			
I_{BVIT}	Input HIGH Current Breakdown (I/O)	54F			1.0	mA	Max	V_{IN} = 5.5V (A_n, B_n)
		74F			0.5			
I_{CEX}	Output HIGH Leakage Current	54F			250	μA	Max	V_{OUT} = V_{CC}
		74F			50			
V_{ID}	Input Leakage Test	74F	4.75			V	0.0	I_{ID} = 1.9 μA All Other Pins Grounded
I_{OD}	Output Leakage Circuit Current	74F			3.75	μA	0.0	V_{IOD} = 150 mV All Other Pins Grounded
I_{IL}	Input LOW Current				−0.6	mA	Max	V_{IN} = 0.5V (Non I/O Pins)
I_{IH} + I_{OZH}	Output Leakage Current				70	μA	Max	V_{OUT} = 2.7V (A_n, B_n)
I_{IL} + I_{OZL}	Output Leakage Current				−650	μA	Max	V_{OUT} = 0.5V (A_n, B_n)
I_{OS}	Output Short-Circuit Current		−100		−225	mA	Max	V_{OUT} = 0V
I_{ZZ}	Bus Drainage Test				500	μA	0.0V	V_{OUT} = 5.25V
I_{CCH}	Power Supply Current				135	mA	Max	V_O = HIGH
I_{CCL}	Power Supply Current				150	mA	Max	V_O = LOW
I_{CCZ}	Power Supply Current				150	mA	Max	V_O = HIGH Z

'F646/'F648

AC Electrical Characteristics: See Section 2 for Waveforms and Load Configurations

Symbol	Parameter	74F $T_A = +25°C$ $V_{CC} = +5.0V$ $C_L = 50\ pF$		54F $T_A, V_{CC} = Mil$ $C_L = 50\ pF$		74F $T_A, V_{CC} = Com$ $C_L = 50\ pF$		Units	Fig. No.
		Min	Max	Min	Max	Min	Max		
f_{max}	Maximum Clock Frequency	90		75		90		MHz	2–1
t_{PLH} t_{PHL}	Propagation Delay Clock to Bus	2.0 2.0	7.0 8.0	2.0 2.0	8.5 9.5	2.0 2.0	8.0 9.0	ns	2–3
t_{PLH} t_{PHL}	Propagation Delay Bus to Bus ('F646)	1.0 1.0	7.0 6.5	1.0 1.0	8.0 8.0	1.0 1.0	7.5 7.0	ns	2–3
t_{PLH} t_{PHL}	Propagation Delay Bus to Bus ('F648)	2.0 1.0	8.5 7.5	1.0 1.0	10.0 9.0	2.0 1.0	9.0 8.0	ns	2–3
t_{PLH} t_{PHL}	Propagation Delay SBA or SAB to A or B	2.0 2.0	8.5 8.0	2.0 2.0	11.0 10.0	2.0 2.0	9.5 9.0	ns	2–3
t_{PZH} t_{PZL}	Enable Time $\overline{OE}$ to A or B	2.0 2.0	8.5 12.0	2.0 2.0	10.0 13.5	2.0 2.0	9.0 12.5	ns	2–5
t_{PHZ} t_{PLZ}	Disable Time $\overline{OE}$ to A or B	1.0 2.0	7.5 9.0	1.0 2.0	9.0 11.0	1.0 2.0	8.5 9.5	ns	2–5
t_{PZH} t_{PZL}	Enable Time DIR to A or B	2.0 2.0	14.0 13.0	2.0 2.0	16.0 15.0	2.0 2.0	15.0 14.0	ns	2–5
t_{PHZ} t_{PLZ}	Disable Time DIR to A or B	1.0 2.0	9.0 11.0	1.0 2.0	10.0 12.0	1.0 2.0	9.5 11.5	ns	2–5

'F646/'F648

AC Operating Requirements: See Section 2 for Waveforms

Symbol	Parameter	74F $T_A = +25°C$ $V_{CC} = +5.0V$		54F $T_A, V_{CC} = Mil$		74F $T_A, V_{CC} = Com$		Units	Fig. No.
		Min	Max	Min	Max	Min	Max		
$t_s(H)$ $t_s(L)$	Setup Time, HIGH or LOW Bus to Clock	5.0 5.0		5.0 5.0		5.0 5.0		ns	2–6
$t_h(H)$ $t_h(L)$	Hold Time, HIGH or LOW Bus to Clock	2.0 2.0		2.5 2.5		2.0 2.0		ns	2–6
$t_w(H)$ $t_w(L)$	Clock Pulse Width HIGH or LOW	5.0 5.0		5.0 5.0		5.0 5.0		ns	2–4

7

'F646B

AC Electrical Characteristics: See Section 2 for Waveforms and Load Configurations

Symbol	Parameter	74F $T_A = +25°C$ $V_{CC} = +5.0V$ $C_L = 50\ pF$		54F $T_A, V_{CC} = Mil$ $C_L = 50\ pF$		74F $T_A, V_{CC} = Com$ $C_L = 50\ pF$		Units	Fig. No.
		Min	Max	Min	Max	Min	Max		
f_{max}	Maximum Clock Frequency	165				150		MHz	2-1
t_{PLH} t_{PHL}	Propagation Delay Clock to Bus	2.5 3.0	7.0 7.5			2.5 3.0	8.0 8.0	ns	2-3
t_{PLH} t_{PHL}	Propagation Delay Bus to Bus	2.0 2.0	6.0 6.0			2.0 2.0	7.0 7.0	ns	2-3
t_{PLH} t_{PHL}	Propagation Delay SBA or SAB to A or B	2.5 2.5	7.5 7.5			2.5 2.5	8.5 8.5	ns	2-3
t_{PZH} t_{PZL}	Enable Time $\overline{OE}$ to A or B	2.5 2.5	6.5 9.0			2.5 2.5	8.0 10.0	ns	2-5
t_{PHZ} t_{PLZ}	Disable Time $\overline{OE}$ to A or B	1.5 2.0	6.5 7.0			1.5 2.0	7.5 8.5	ns	
t_{PZH} t_{PZL}	Enable Time DIR to A or B	2.0 3.0	7.0 9.5			2.0 3.0	8.5 10.0	ns	
t_{PHZ} t_{PLZ}	Disable Time DIR to A or B	1.5 2.5	7.5 8.5			1.5 2.5	8.5 9.5	ns	2-5

'F646B

AC Operating Requirements: See Section 2 for Waveforms

Symbol	Parameter	74F $T_A = +25°C$ $V_{CC} = +5.0V$		54F $T_A, V_{CC} = Mil$		74F $T_A, V_{CC} = Com$		Units	Fig. No.
		Min	Max	Min	Max	Min	Max		
$t_s(H)$ $t_s(L)$	Setup Time, HIGH or LOW Bus to Clock	5.0 5.0				4.0 4.0		ns	2-6
$t_h(H)$ $t_h(L)$	Hold Time, HIGH or LOW Bus to Clock	1.5 1.5				1.5 1.5		ns	2-6
$t_w(H)$ $t_w(L)$	Clock Pulse Width HIGH or LOW	5.0 5.0				5.0 5.0		ns	2-4